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TECHNOLOGY CENTER R3700

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: **Hyoung June KIM**) Examiner; Quang T. Van
Serial No.: **09/886,940**) Art Unit: 3742
Filed: **June 21, 2001**) Our Ref: B-4227 618899-5/MSG/RP
For: **METHODS & APPARATUSES FOR**) Date: December 15, 2003
HEAT TREATMENT OF) Re: **Amendment and Response**
SEMICONDUCTOR FILMS UPON
THERMALLY SUSCEPTIBLE NON-
CONDUCTING SUBSTRATES

AMENDMENT AND RESPONSE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In reply to the non-final Office Action mailed on August 15, 2003, a response to which is due no later than **February 15, 2004**, Applicant submits this paper together with a petition for a one month extension of time pursuant to 37 C.F.R. 1.136(a) and a check in the amount of \$110.00 for the fee set forth in 37 C.F.R.1.17(a)(1). Please amend the above-identified application as described below and consider the following remarks. **All amendments and remarks herein are made without prejudice.**

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Abstract begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of claims which begins on page 4 of this paper.

Remarks/Arguments begin on page 7 of this paper.

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